

SMM4F12AVCL

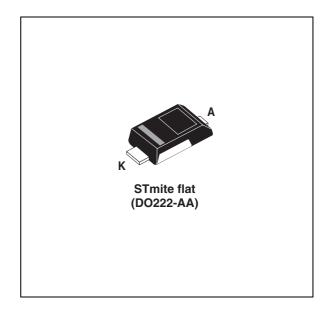
400 W low clamping voltage Transil™

Features

- Typical peak pulse power:
 - 400 W (10/1000 μs)
 - 2.4 kW (8/20 µs)
- Stand off voltage: 12 V
- Unidirectional type
- Low clamping factor
- Low leakage current:
 - 0.2 μA at 25 °C
 - 1 μA at 85 °C
- Operating T_i max: 175 °C
- High power capability at 85 °C: 385 W
- JEDEC registered package outline
- RoHS package
- Halogen free molding compound

Complies with the following standards

- IEC 61000-4-2 level 4:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- MIL STD 883G-Method 3015-7: class3
 - 25 kV (human body model)



Description

The SMM4F12AVCL Transil series has been designed to protect sensitive equipment against electro-static discharges according to IEC 61000-4-2, MIL STD 883 Method 3015, and electrical over stress such as IEC 61000-4-4 and 5. They are generally for surges below 400 W 10/1000 µs.

This planar technology makes it compatible with high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time. Their low clamping voltages provide a better safety margin to protect sensitive circuits with extended life time expectancy such as HDD power combo voltage regulators.

Packaged in STmite flat, this minimizes PCB space consumption (footprint in accordance with IPC 7531 standard).

TM: Transil is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute ratings (T_{amb} = 25 °C)

Symbol	Parameter	Value	Unit			
V _{PP}	Peak pulse voltage (IEC 61000-4-2 contact of	30	kV			
P _{PP}	Peak pulse power dissipation ⁽¹⁾	$T_j \text{ initial} = T_{amb}$ 400		W		
Р	Power dissipation on infinite heatsink	T _{amb} = 125 °C	2.5	W		
T _{stg}	Storage temperature range	-65 to +175	°C			
Тj	Operating junction temperature range	-55 to +175	°C			
TL	Maximum lead temperature for soldering during 10 s 260					

1. For a surge greater than the maximum values, the diode will fail in short-circuit.

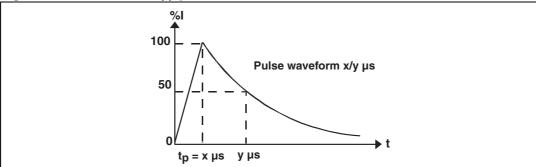
Table 2.Thermal resistances

Symbol	Parameter Value				
R _{th(j-l)}	Junction to leads	20	°C/W		
R _{th(j-a)}	Junction to ambient on PCB with recommended pad layout	250	0/11		

Figure 1. Electrical characteristics - parameter definitions

Symbo V _{RM} V _{BR} V _{CL} I _{RM} I _{PP} aT V _F R _D	 Parameter Stand-off voltage Breakdown voltage Clamping voltage Leakage current @ V_{RM} Peak pulse current Voltage temperature coefficient Forward voltage drop Dynamic resistance 	Unidirectional I_F V _{CL} V _{BR} V _{RM} V _F V V _F V
--	--	---

Figure 2. Definition of I_{PP} pulse





Туре	I _{RM} max@V _{RM}			V _{BR} @I _R ⁽²⁾			V _{CL} @I _{PP} 10/1000 μs		R _D ⁽³⁾ V _{CL} @I _P 10/1000 μs 8/20 μs			R _D ⁽³⁾ 8/20 μs	α Τ⁽⁴⁾	
	25 °C	85 °C		min	typ	max		max			max			max
	μ	Α	v		V		mA	v	Α	Ω	v	Α	Ω	10-4/°C
SMM4F12AVCL	0.2	1	12	13	13.5	14	1	14.3	1	0.3	22.9	100	0.09	8.3

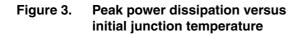
Table 3. Electrical characteristics - parameter values $(T_{amb} = 25 \ ^{\circ}C)^{(1)}$

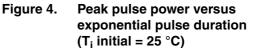
1. Surge capability given for both directions

2. Pulse test: t_p <50ms.

3. To calculate maximum clamping voltage at other surge currents, use the following formula $V_{CLmax} = R_D \times I_{PP} + V_{BRmax}$

4. To calculate V_{BR} versus junction temperature, use the following formula: V_{BR} @ T_j = V_{BR} @ 25 °C x (1 + α T x (T_j - 25))





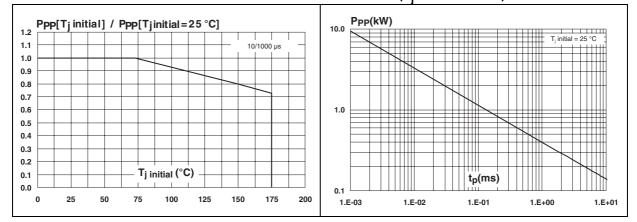
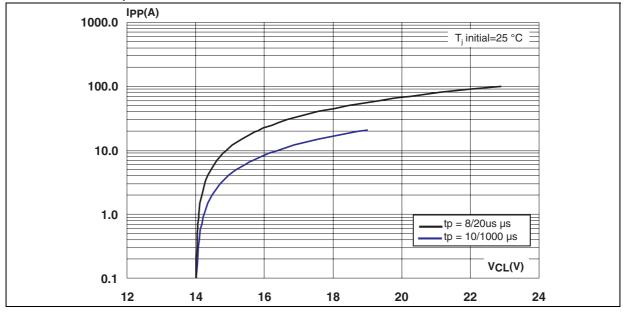


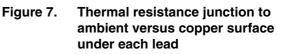
Figure 5. Clamping voltage versus peak pulse current (exponential waveform, maximum values)

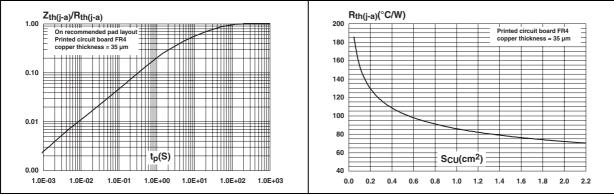




Doc ID 022220 Rev 1

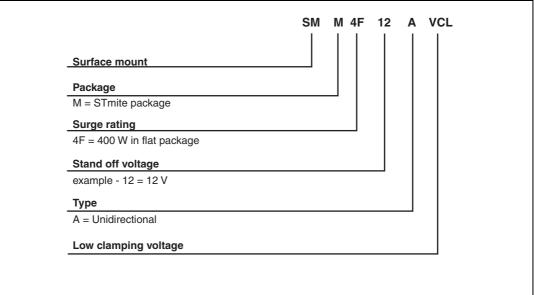
Figure 6. Relative variation of thermal impedance junction to ambient versus pulse duration





2 Ordering information scheme

Figure 8. Ordering information scheme





3 Package information

- Case: JEDEC DO-222AA molded plastic over Planar junction
- Terminals: Solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: The band indicates cathode.
- Flammability: Epoxy meets UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 4. STmite flat dimensions

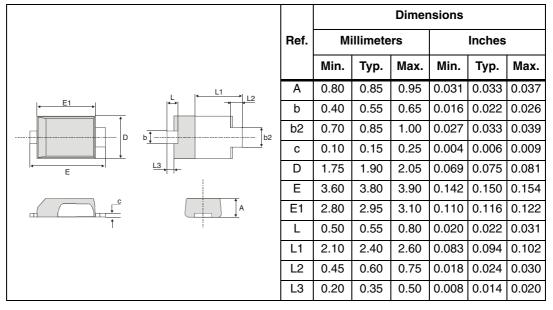
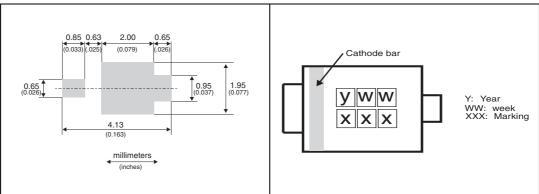


Figure 9. STmite flat footprint dimensions





4 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
SMM4F12AVCL	4UL	STmite flat	16.7 mg	12000	Tape and reel

5 Revision history

Table 6. Document revision history

Date	Revision	Changes
13-Sep-2011	1	First issue.



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY TWO AUTHORIZED ST REPRESENTATIVES, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2011 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Doc ID 022220 Rev 1

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: <u>SMM4F12AVCL</u>